

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT6533580

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
DAVID CHAMPION	10/29/2018
PAVAN SURI	10/29/2018
JOHN LIEBESKIND	10/24/2018
RICHARD SEAVER	10/23/2018
RECEIVING PARTY DATA	
Name:	Hewlett-Packard Development Company, L.P.
Street Address:	10300 Energy Drive
City:	Spring
State/Country:	TEXAS
Postal Code:	77389
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17059072
CORRESPONDENCE DATA	
Fax Number:	(970)778-4063
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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ATTORNEY DOCKET NUMBER:	85958561
NAME OF SUBMITTER:	JULIA CHURCH DIERKER
SIGNATURE:	/Julia Church Dierker, Reg. No. 33368/
DATE SIGNED:	02/04/2021
Total Attachments: 4	
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HP Inc.
3390 E. Harmony Road
Mail Stop 35
Fort Collins, Colorado 80528

RECORD ID: 85007626

ASSIGNMENT OF PATENT APPLICATION

I, the undersigned, for good and valuable consideration, the receipt of which is hereby acknowledged, agree to assign and transfer and hereby assign and transfer to HEWLETT-PACKARD DEVELOPMENT COMPANY, L.P., a Texas Limited Partnership having its principal place of business in Houston, Texas, (hereinafter "HPDC"), its successors, and its assigns, my entire right, title, and interest, including all rights of priority, in, to, and under an application for patent entitled (English-language title in parentheses if said application for patent is in another language):

SINTERING FURNACE

Filing Date: November 25, 2020 Application No.: 17/059,072 Patent Office: US

the subject matter, including any and all inventions, improvements, and discoveries, set forth in said application for patent (as used herein "patent" refers to any form of intellectual property protection including, without limitation, invention rights, utility patent rights, design rights, and utility model rights) (hereinafter "Inventions"); any and all existing and future applications for patent of any country or region or under any international agreement for any of said Inventions (including, without limitation, said application for patent, any and all applications for patent directly or indirectly claiming priority to or benefit of any application for patent for any of said Inventions, any and all applications for patent from which any application for patent for any of said Inventions directly or indirectly claims priority or benefit, and any and all continuation applications of, continuation-in-part applications (hereinafter CIPs) of, divisional applications of, national-phase applications of, regional-phase applications of, renewals of, and substitutes for any application for patent for any of said Inventions) (hereinafter "Applications for Patent"); any and all patents which may be granted on or as a result of said Applications for Patent (hereinafter "Patents"); and any and all reissues, reexaminations, and extensions of said Applications for Patent or said Patents.

I HEREBY represent that I convey my full rights in all countries and regions and under all international agreements to the entire right, title, and interest herein assigned and transferred, and that I have not executed and will not execute any agreement in conflict herewith;

AND I HEREBY authorize HPDC, its successors, its assigns, its nominees, and its legal representatives to file said Applications for Patent in its name or in my name in any country or region or under any international agreement, and further authorize HPDC, its successors, its assigns, its nominees, and its legal representatives to insert the filing date, application number, and patent office of said application for patent, now identified by the Record ID and title set forth above, when known to them;

AND I HEREBY authorize and request the officials of all countries and regions and under all international agreements whose duty it is to issue patents, to issue to HPDC, its successors, or its assigns, as assignee of my entire right, title, and interest, said Patents, in accordance with the terms of this assignment and transfer;

AND I HEREBY covenant and agree that I will, each time a request is made, and without undue delay, execute and deliver all such papers as may be necessary or desirable to perfect the title in said Inventions, Applications for Patent, and Patents, to HPDC, its successors, or its assigns; communicate to HPDC, its successors, its assigns, its nominees, or its legal representatives, all known facts respecting said Inventions, Applications for Patent, and Patents; testify in any legal or administrative proceedings and sign all lawful papers (including, without limitation, divisional applications, continuation applications, CIPs, and reissue applications) relating to said Inventions, Applications for Patent, and Patents; and make all rightful oaths and declarations and generally to do everything possible to aid HPDC, its successors, its assigns, its nominees, and its legal representatives to obtain, maintain, and enforce, for its or their own benefit, proper intellectual property protection for said Inventions, Applications for Patent, and Patents, provided the expenses which may be incurred by me in lending such cooperation and assistance are paid by HPDC, its successors, its assigns, its nominees, or its legal representatives.

IN WITNESS WHEREOF, I hereunto set my hand and seal:


Inventor's Signature

29 20 2018
Day Month Year

David Champion
Given (First and Middle) Name(s) Family Name

HP Inc.
3390 E. Harmony Road
Mail Stop 35
Fort Collins, Colorado 80528

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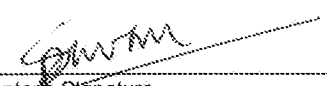
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IN WITNESS WHEREOF, I hereunto set my hand and seal:



Inventor's Signature

Pavan Suri

Given (First and Middle) Name(s)

Family Name

29
Day

October
Month

2018
Year

HP Inc.
3390 E. Harmony Road
Mail Stop 35
Fort Collins, Colorado 80528

RECORD ID: 85007626

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IN WITNESS WHEREOF, I hereunto set my hand and seal:

John Liebeskind
Inventor's Signature

24 October 2018
Day Month Year

John Liebeskind
Given (First and Middle) Name(s) Family Name

HP Inc.
3390 E. Harmony Road
Mail Stop 35
Fort Collins, Colorado 80528

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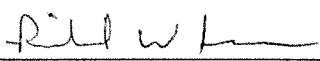
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IN WITNESS WHEREOF, I hereunto set my hand and seal:


Inventor's Signature

23 OCTOBER 2018
Day Month Year

Richard Seaver
Given (First and Middle) Name(s) Family Name